



MC2609130-00A-OPC

Mellanox® MC2609130-00A Compatible TAA compliant 40GBase-CU QSFP+ to 4xSFP+ Direct Attach Cable (Passive Twinax, 50cm)

Features

- Hybrid cable conforms to the Small Form Factor SFF-8436 and SFF-8431
- Support for multi-gigabit data rates: 1 Gbps - 10Gbps (per channel)
- Maximum aggregate data rate: 40 Gbps (4 x 10 Gbps)
- High-Density QSFP 38-PIN and 4x SFP
- 20-PIN connector
- Power Supply: +3.3V
- Operating temperature: 0 to 70 Celsius
- Lower power consumption: 0.02W
- RoHS Compliant and Lead-Free



Applications:

- 10/40Gigabit Ethernet
- Infiniband 4x SDR, DDR, QDR

Product Description

This is a Mellanox® MC2609130-00A compatible 40GBase-CU QSFP+ to 4xSFP+ direct attach cable that operates over passive copper with a maximum reach of 0.5m (1.6ft). It has been programmed, uniquely serialized, and data-traffic and application tested to ensure it is 100% compliant and functional. This direct attach cable is TAA (Trade Agreements Act) compliant, and is built to comply with MSA (Multi-Source Agreement) standards. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

OptioConnect's transceivers are RoHS compliant and lead-free.

Absolute Maximum Ratings

Parameter	Symbol	Min.	Typ.	Max.	Unit
Storage Ambient Temperature	T _{stg}	-40		85	°C
Operating Case Temperature	T _c	0		70	°C
Power Supply Voltage	V _{cc}	3.14	3.3	3.47	V
Power Dissipation	P _{DISS}			0.02	W

Pin Descriptions

Pin	Logic	Symbol	Name/Description	Notes
1		GND	Module Ground.	1
2	CML-I	Tx2-	Transmitter Inverted Data Input.	
3	CML-I	Tx2+	Transmitter Non-Inverted Data Input.	
4		GND	Module Ground.	1
5	CML-I	Tx4-	Transmitter Inverted Data Input.	
6	CML-I	Tx4+	Transmitter Non-Inverted Data Input.	
7		GND	Module Ground.	1
8	LVTTL-I	ModSelL	Module Select.	2
9	LVTTL-I	ResetL	Module Reset.	2
10		VccRx	+3.3V Receiver Power Supply.	
11	LVC MOS-I	SCL	2-Wire Serial Interface Clock.	2
12	LVC MOS-I/O	SDA	2-Wire Serial Interface Data.	2
13		GND	Module Ground.	1
14	CML-O	Rx3+	Receiver Non-Inverted Data Output.	
15	CML-O	Rx3-	Receiver Inverted Data Output.	
16		GND	Module Ground.	1
17	CML-O	Rx1+	Receiver Non-Inverted Data Output.	
18	CML-O	Rx1-	Receiver Inverted Data Output.	
19		GND	Module Ground.	1
20		GND	Module Ground.	1
21	CML-O	Rx2-	Receiver Inverted Data Output.	
22	CML-O	Rx2+	Receiver Non-Inverted Data Output.	
23		GND	Module Ground.	1
24	CML-O	Rx4-	Receiver Inverted Data Output.	
25	CML-O	Rx4+	Receiver Non-Inverted Data Output.	
26		GND	Module Ground.	1
27	LVTTL-O	ModPrsL	Module Present. Internally pulled down to the GND.	
28	LVTTL-O	IntL	Interrupt output should be pulled up on the host board.	2
29		VccTx	+3.3V Transmitter Power Supply.	
30		Vcc1	+3.3V Power Supply.	
31	LVTTL-I	LPMode	Low-Power Mode.	2

32		GND	Module Ground.	1
33	CML-I	Tx3+	Transmitter Non-Inverted Data Input.	
34	CML-I	Tx3-	Transmitter Inverted Data Input.	
35		GND	Module Ground.	1
36	CML-I	Tx1+	Transmitter Non-Inverted Data Input.	
37	CML-I	Tx1-	Transmitter Inverted Data Input.	
38		GND	Module Ground.	1

Notes:

1. GND is the symbol for signal and supply (power) common for the QSFP+ module. All are common within the QSFP+ module, and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal-common ground plane.
2. VccRx, Vcc1, and VccTx are the receiver and transmitter power supplies and shall be applied concurrently. Requirements defined for the host side of the Host Edge Card Connector are listed. Recommended host board power supply filtering is shown. VccRx, Vcc1, and VccTx may be internally connected within the QSFP+ module in any combination. The connector pins are each rated for a maximum current of 500mA.

Mechanical Specifications



OptioConnect

Innovation for the Future of High-Speed Networking

Who We Are

OptioConnect is reshaping the landscape of communication and high-speed networking through intelligent technology. With a core focus on cutting edge technology, we deliver smarter fiber optic solutions for enterprise networks, data centers, and next-gen telecom infrastructures.

What We Do

At OptioConnect, we fuse advanced engineering with intelligent automation to drive the future of networking. Our AI-integrated solutions are designed to optimize performance and streamline operations with:

- Superior Performance
- Network and traffic optimization
- Intelligent energy management
- Seamless OEM compatibility
- Scalable cost-efficiency

Smarter Networks by Design

Innovation isn't just a goal—it's our process. We embed AI and machine learning across our R&D and product lines, enabling adaptive performance, automated tuning, and faster deployment cycles. The result? Networks that don't just work—they learn, evolve, and outperform.

Our Team

Our engineers, data scientists, and network architects bring decades of experience and a future-focused mindset. We provide hands-on support with intelligent insights that turn complex challenges into simple solutions.

Our Mission

To deliver AI-enhanced connectivity that reduces cost, increases speed, and maximizes efficiency—empowering our partners to operate at the forefront of a rapidly evolving digital world.

Let's Connect

Discover how OptioConnect's intelligent infrastructure solutions can power your network's next leap forward.

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